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Vishay Siliconix

P-Channel 30 V (D-S) MOSFET



Marking code: BT

DDODUOT CUMMADY					
PRODUCT SUMMARY					
V _{DS} (V)	-30				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10 \text{ V}$	0.0312				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0513				
Q _g typ. (nC)	4.5				
I _D (A) a, d	-8				
Configuration	Single				

FEATURES

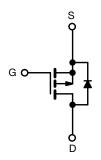
- TrenchFET® Gen IV p-channel power MOSFET
- \bullet 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

Load switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3483DDV-T1-GE3

ABSOLUTE MAXIMUM RATINO	3S (T _A = 25 °C, ι	inless otherwise	noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS}	-20 / +16	v	
	T _C = 25 °C		-8 ^a		
Oti	T _C = 70 °C	1 .	-6.4		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-6.4 ^{b, c}		
	T _A = 70 °C		-5.2 ^{b, c}	А	
Pulsed drain current (t = 100 µs)		I _{DM} -30			
Continuous durin dinda accument	T _C = 25 °C		-2.5		
Continuous source-drain diode current	T _A = 25 °C	l _S	-1.67 ^{b, c}		
Maximum power dissipation	T _C = 25 °C		3		
	T _C = 70 °C		2	14/	
	T _A = 25 °C	P _D	2 ^{b, c}	W	
	T _A = 70 °C	1	1.3 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT		
Maximum junction-to-ambient ^b	t ≤ 5 s	R_{thJA}	52	62.5	°C/W	
Maximum junction-to-case (drain)	Steady state	R_{thJC}	34	41		

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 110 °C/W

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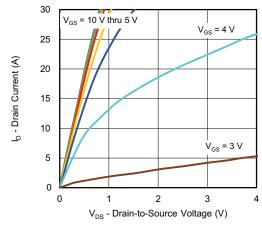
ARAMETER SYMBOL TEST CONDITIONS		TEST CONDITIONS	MIN.	l. TYP.	MAX.	UNIT
Static			·		•	•
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 A	-	-17.6	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	5	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-	-2.2	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = -20 \text{ V} / +16 \text{ V}$	-	-	± 100	nA
Zero gate voltage drain current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	μΑ
	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V, T _J = 70 °C	-	-	-10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-5	-	-	Α
Duning anyone on other projections 2	Б	$V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	-	0.0260	0.0312	_
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_D = -3 \text{ A}$	-	0.0410	0.0513	Ω
Forward transconductance ^a	9 _{fs}	$V_{DS} = -10 \text{ V}, I_D = -5 \text{ A}$	-	30	-	S
Dynamic ^b					•	
Input capacitance	C _{iss}		-	580	-	
Output capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	245	-	pF
Reverse transfer capacitance	C _{rss}		-	35	-	1
Total gate charge	Qg	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -6.4 \text{ A}$	-	9.5	14.5	nC
			-	4.5	9	
Gate-source charge	Q _{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -6.4 \text{ A}$	-	2.6	-	
Gate-drain charge	Q_{gd}		-	1.3	-	
Gate resistance	R_g	f = 1 MHz	3.4	20	34	Ω
Turn-on delay time	t _{d(on)}		-	15	30	
Rise time	t _r	$V_{DD} = -15 \text{ V}, R_L = 2.9 \Omega, I_D \cong -5.2 \text{ A},$	-	33	66	1
Turn-off delay time	t _{d(off)}	$V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	30	60	1
Fall time	t _f		-	40	60	1
Turn-on delay time	t _{d(on)}		-	26	52	ns
Rise time	t _r	V_{DD} = -15 V, R_L = 2.9 Ω , $I_D \cong$ -5.2 A,	-	140	280	
Turn-off delay time	t _{d(off)}	$V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$	-	26	52	
Fall time	t _f		-	42	84	1
Drain-Source Body Diode Characteristic	cs				•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-2.5	_
Pulse diode forward current	I _{SM}		-	-	-30	A
Body diode voltage	V_{SD}	$I_{S} = -5.2 \text{ A}, V_{GS} = 0 \text{ V}$	-	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}		-	21	32	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = -5.2 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	9	18	nC
Reverse recovery fall time	t _a	$T_J = 25 ^{\circ}\text{C}$	-	9	-	
Reverse recovery rise time	t _b		-	12	_	ns

Notes

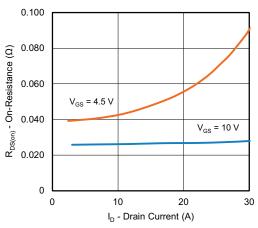
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

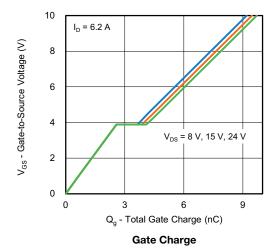


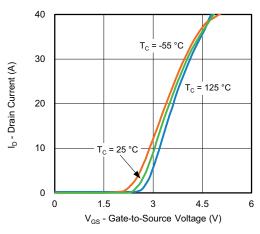


Output Characteristics

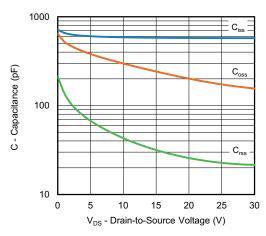


On-Resistance vs. Drain Current and Gate Voltage

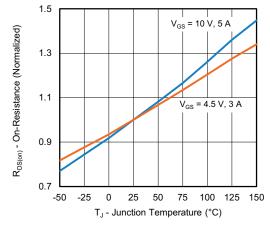




Transfer Characteristics

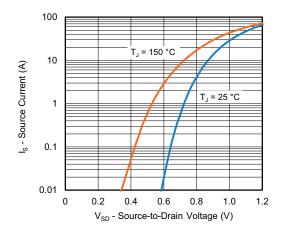


Capacitance

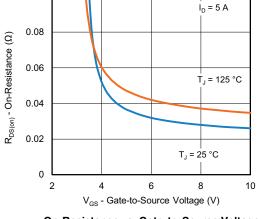


On-Resistance vs. Junction Temperature



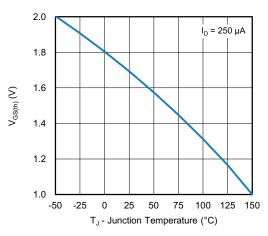


Source-Drain Diode Forward Voltage

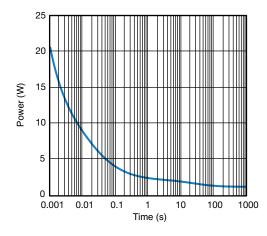


0.10

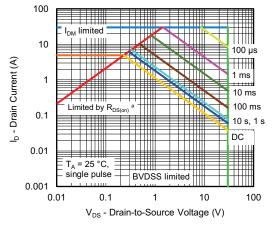
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

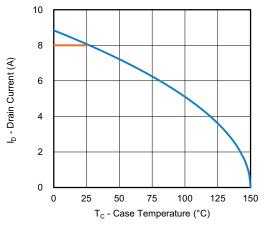


Safe Operating Area, Junction-to-Ambient

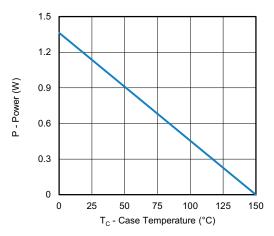
Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

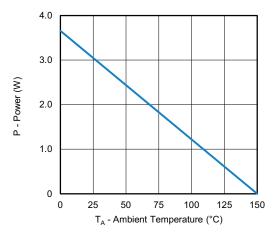




Current Derating a





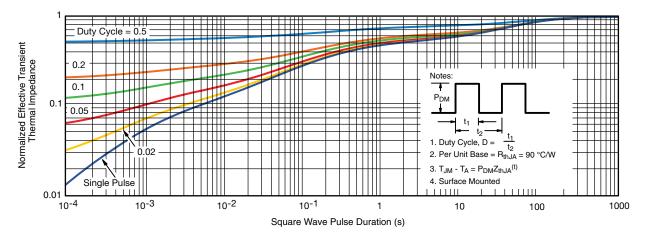


Power, Junction-to-Ambient

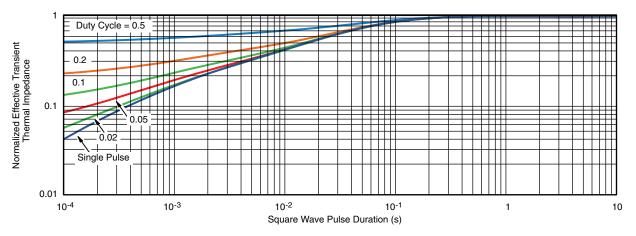
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

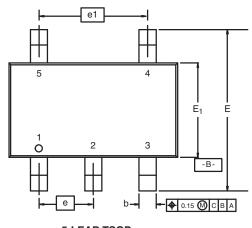
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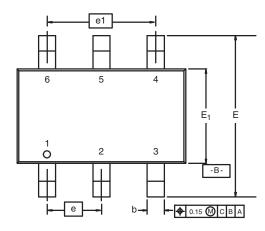




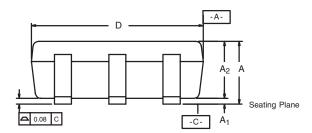
TSOP: 5/6-LEAD

JEDEC Part Number: MO-193C

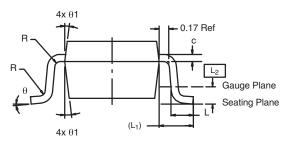




5-LEAD TSOP







	MIL	LIMETER	RS	INCHES		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.91	-	1.10	0.036	-	0.043
A ₁	0.01	-	0.10	0.0004	-	0.004
A ₂	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
С	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E ₁	1.55	1.65	1.70	0.061	0.065	0.067
е		0.95 BSC		0.0374 BSC		
e ₁	1.80 1.90 2.00			0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L ₁	0.60 Ref				0.024 Ref	
L ₂	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ_1		7° Nom		7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06 DWG: 5540						

Document Number: 71200

18-Dec-06

VISHAY.

RECOMMENDED MINIMUM PADS FOR TSOP-6



Recommended Minimum Pads Dimensions in Inches/(mm)

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